

SOT-23 Plastic-Encapsulate MOSFETs

BC2300 N-Channel Enhancement Mode MOSFET

■ Features

- V_{DS}=20V,RDS(ON)=40mΩ @VGS=4.5V, ID=5.0A
- V_{DS}=20V,RDS(ON)=60mΩ @VGS=2.5V, ID=4.0A
- V_{DS}=20V,,RDS(ON)=75mΩ @VGS=1.8V, ID=1.0A
- Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and Maximum DC current capability

■ Absolute Maximum Ratings Ta = 25 °C

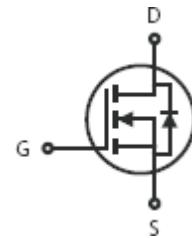
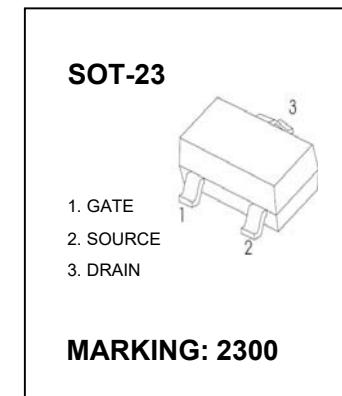
Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{Gs}	±10	V
Drain-Current -Continuous * T _J =125 °C -Pulsed	I _D	3.8	A
	I _{DM}	15	A
Power Dissipation *	P _D	1.25	W
Thermal Resistance,Junction- to-Ambient	R _{thJA}	100	°C/W
Operating Junction and Storage Temperature Range	T _{j,Tstg}	-55 to 150	°C

* Surface Mounted on FR 4 Board ,t≤10 sec.

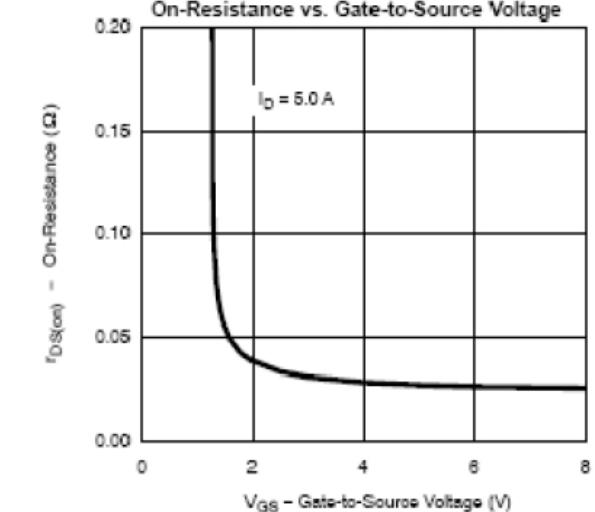
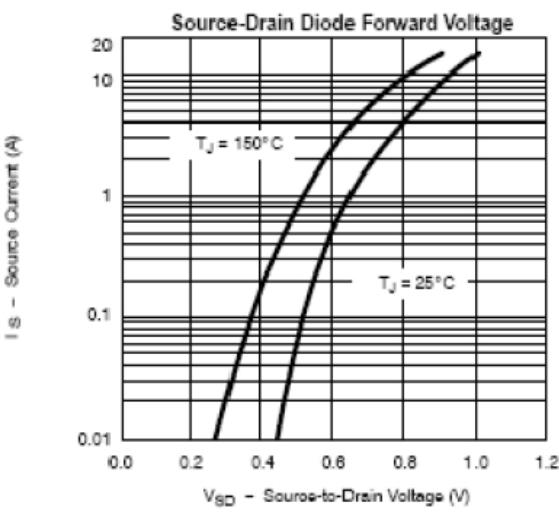
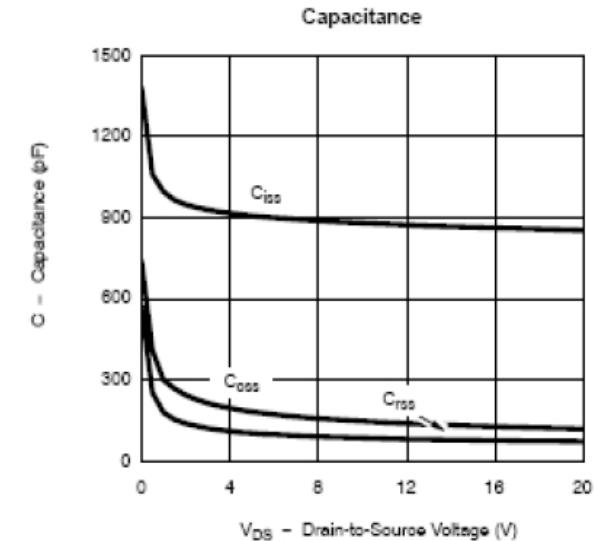
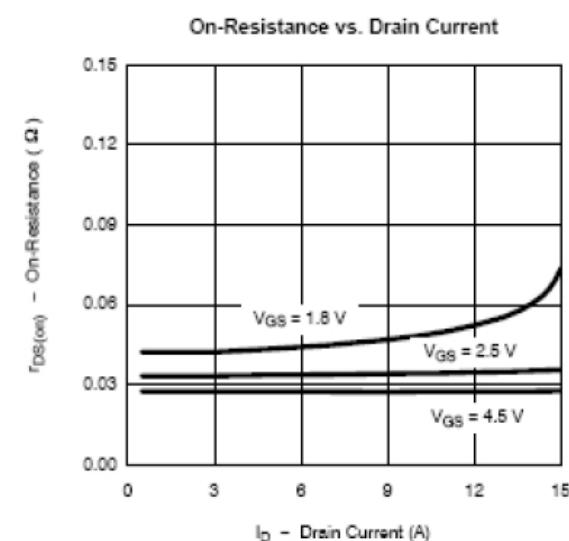
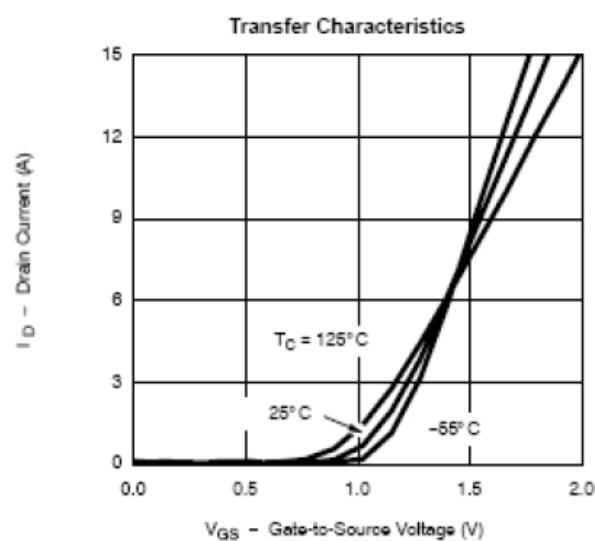
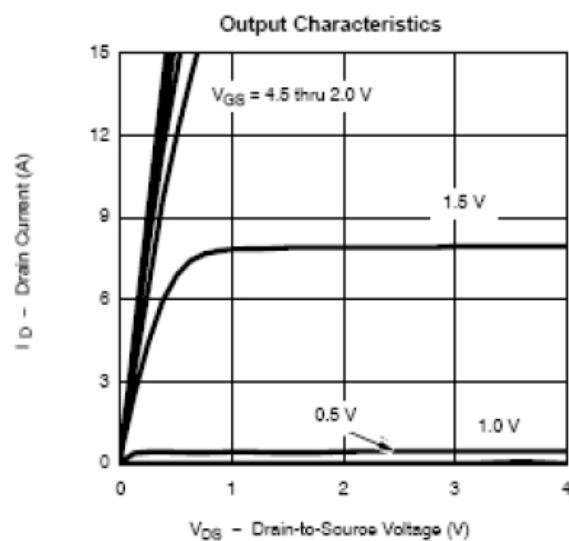
■ Electrical Characteristics Ta = 25 °C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V _{DSS}	V _{Gs} =0V, I _D =250uA	20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{Gs} =0V			1	uA
Gate-Body Leakage	I _{GSS}	V _{Gs} = ± 10V, V _{DS} =0V			±100	nA
Gate Threshold Voltage *	V _{Gs(th)}	V _{Gs} =V _{DS} , I _D =250uA	0.6	0.78	1.5	V
Drain- Source on-state Resistance *	R _{DSS(ON)}	V _{Gs} =4.5V, I _D =5.0A		32	40	mΩ
		V _{Gs} =2.5V, I _D =4.0A		50	60	mΩ
		V _{Gs} =1.8V, I _D =1.0A		62	75	mΩ
On-State Drain Current *	I _{D(ON)}	V _{DS} =5V, V _{Gs} =4.5V	18			A
Forward Transconductance *	g _{fs}	V _{DS} =5V, I _D =5A	5			S
Input Capacitance	C _{iss}	V _{DS} = 15V, V _{Gs} = 0V, f = 1.0MHZ		888		pF
Output Capacitance	C _{oss}			144		pF
Reverse Transfer Capacitance	C _{rss}			115		pF
Turn-On Delay Time	t _{d(on)}	V _{DD} =10V, I _D =1A, V _{Gs} =4.5V, R _L =10Ω , R _{GEN} =6Ω		31.8		ns
Rise Time	t _r			14.5		ns
Turn-Off Delay Time	t _{d(off)}			50.3		ns
Fall Time	t _f			31.9		ns
Total Gate Charge	Q _g	V _{DS} = 10V, I _D = 3.5A, V _{Gs} = 4.5V		16.8		nC
Gate-S ource Charge	Q _{gs}			2.5		nC
Gate-Drain Charge	Q _{gd}			5.4		nC
Drain-Source Diode Forward Current *	I _s				1.25	A
Diode Forward Voltage	V _{SD}	V _{Gs} =0V, I _s =1.25A		0.825	1.2	V

* Pulse Test:Pulse Width≤300μs ,Duty Cycle≤2%



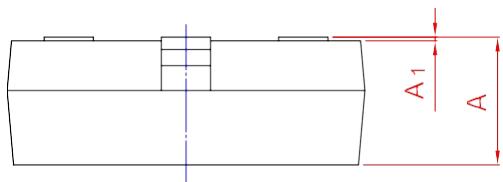
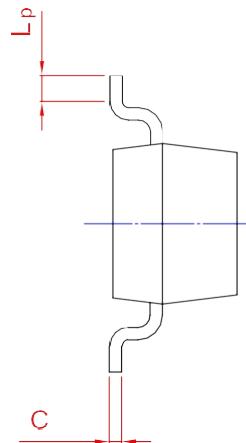
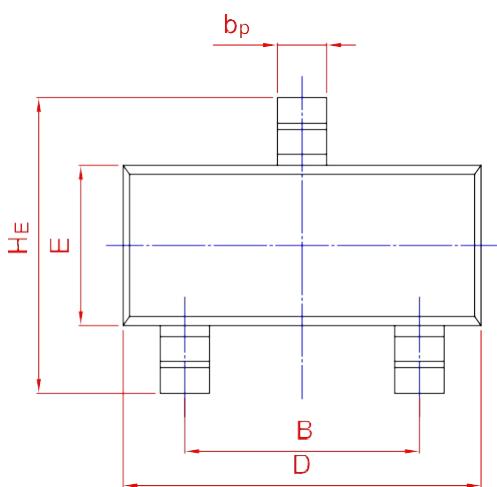
Typical Characteristics



PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-23



UNIT	A	B	b_p	C	D	E	H_E	A_1	L_p
mm	1.40 0.95	2.04 1.78	0.50 0.35	0.19 0.08	3.10 2.70	1.65 1.20	3.00 2.20	0.100 0.013	0.50 0.20